

Unibond electrodes are used for parallel gap bonding and reflow soldering. Generally, RWMA2 copper Unibond electrodes are used with resistive and/or hard materials such as gold-plated kovar and nickel. Molybdenum Unibond electrodes are used for bonding conductive or soft materials such as copper or gold.

The face of a Unibond electrode measures 0.020 inches (0.5 mm) wide by 0.030 inches (0.75 mm) deep. In unfixtured applications, this limits their use to bonding ribbons (wire) which are at least 0.010 inches (0.25 mm) wide because of the limited visibility.

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OUR TECHNOLOGIES



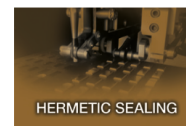
RESISTANCE WELDING



LASER WELDING



LASER MARKING



HERMETIC SEALING



HOT BAR REFLOW
SOLDERING & BONDING



SYSTEMS SOLUTIONS

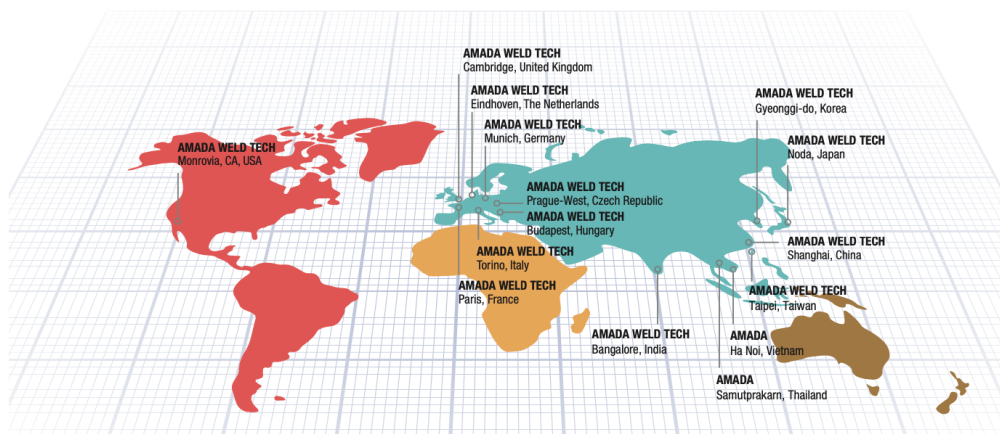


LASER CUTTING



MICRO TIG WELDING

OUR SALES OFFICES



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